

CLICdp Tracker Technology Meeting

Update of the Mechanics for the Tracking Detector

Szymon Sroka, Fernando Duarte Ramos



Presentation Layout

- Design proposal of support structures & Petals for the ITD :
 - Requirements & Objectives
 - Introduction to Design and the Concept Development Process
 - Design proposal of Petals
 - Design proposal of Support Structures
- > Summary

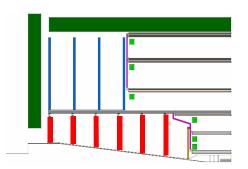


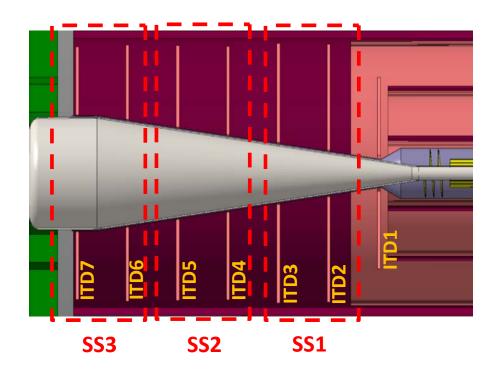
Requirements

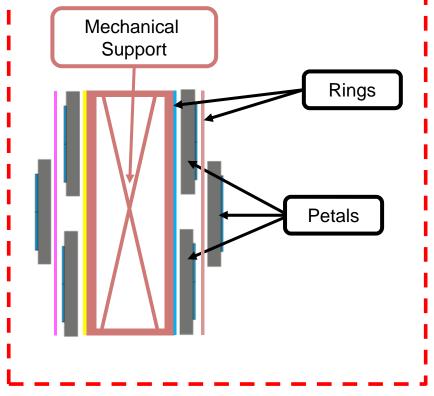
- Due to the fact that the Inner Sub-System includes the beam pipe, the supports
 for all components, including the Inner Tracker Disks should be designed with
 two halves.
- Support structure should be easily attachable to the Support Tube and be compatible with the gaps that were established for the services.
- Petals from two different Tracker disks would share the same support structure.
- For the time being, we assumed the scenario where the petals of one Tracker Disk would be mounted in two different planes (to guarantee the overlap).

Objectives

- One of the major objectives is to minimize the value of radiation length and make the structure as much invisible for the particles as possible.
- Due to the detector performance, we are looking for a stiff and lightweight construction.
- Looking for a simple and coherent design of the support structures and petals.
- Number of designs regarding the support structures and petals should be minimized.

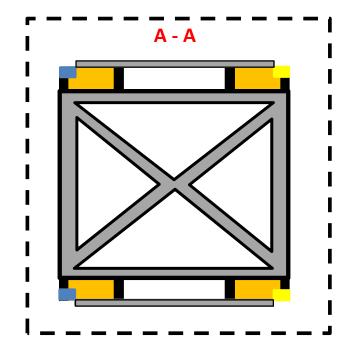


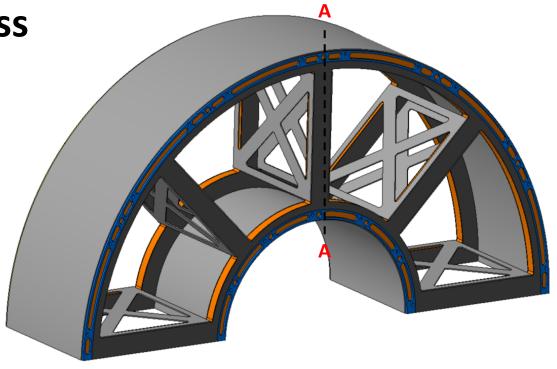




Introduction to Design and the Concept

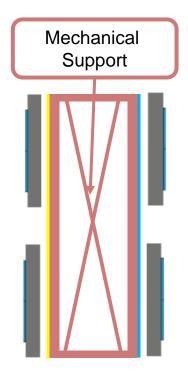
Development Process

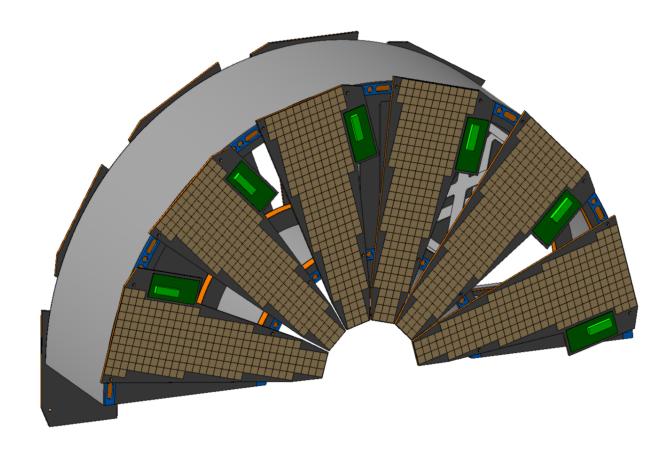


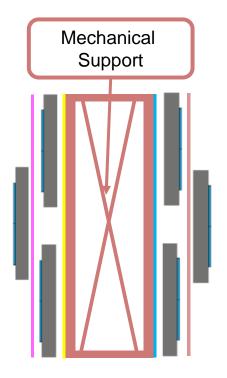


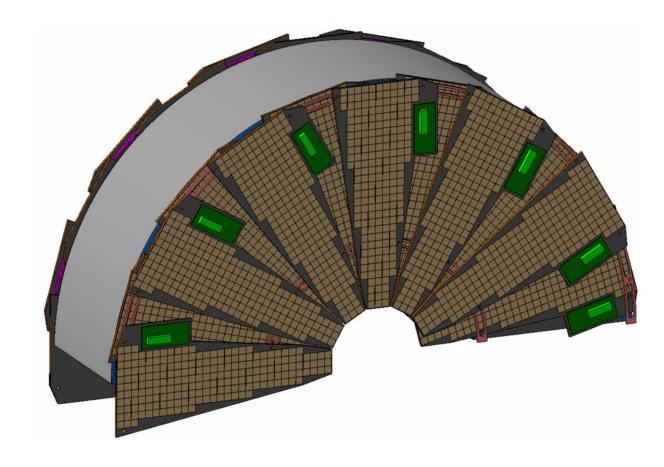
Design details:

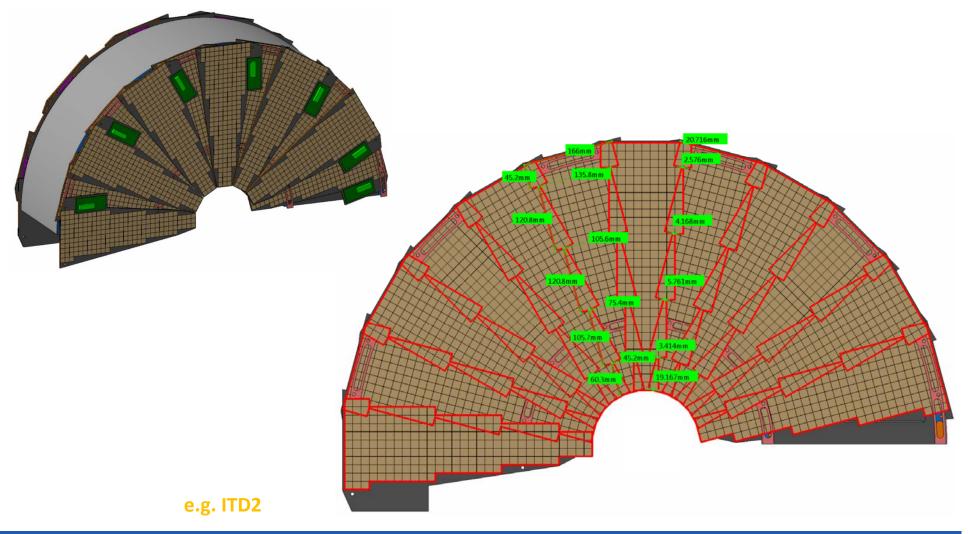
- 2 Sandwich faces [CFS-CORE-CFS]
- 2 Rings on each side (in total 4) e.g. made of PEEK
- Horizontal Interlinks Inner & Outer CF Shell
- Radial Interlinks CF Plates











Design of Petals

Assumptions:

Module:

- Silicon Pixel Chips: T = 300 μ m
- FPC Metal layer (Aluminium): T = 50 μ m
- FPC Insulating layer (Polyimide): T = 100 μ m
- Glue (Eccobond 54): T = 100 μ m

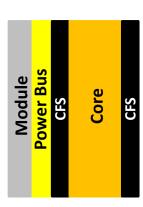
Power Bus:

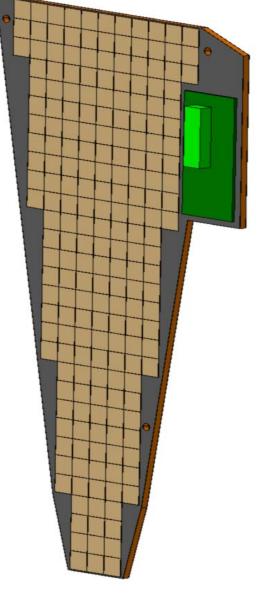
- Metal layer (Aluminium): T = 200 μ m
- Insulating layer (Polyimide): T = 200 μ m
- Glue (Eccobond 54): T = 100 μ m

Electrical connector

• Mechanical layout:

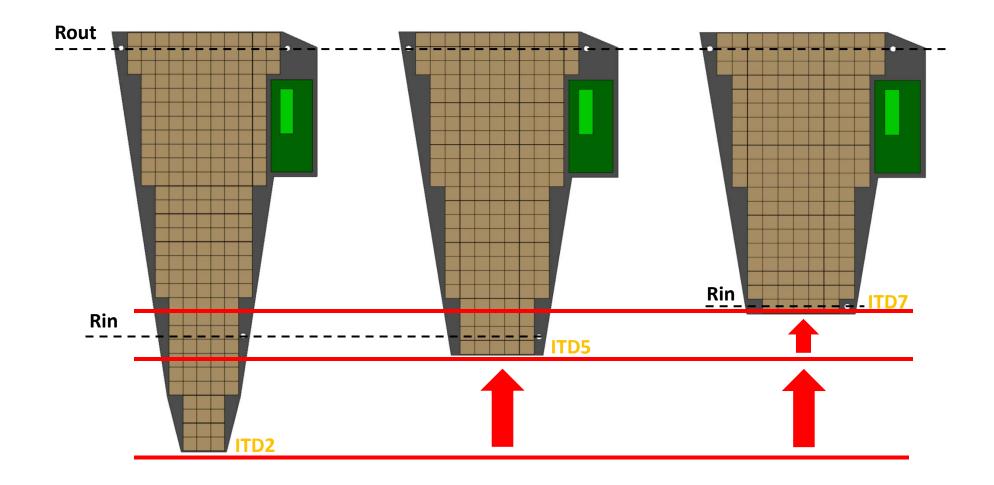
- CF Skins: e.g. Toray M55J, T = 210 μ m
- CORE: e.g. Rohacell IG51, T = 5 mm
- Cooling pipes (missed so far)
- Graphite foam (missed so far)



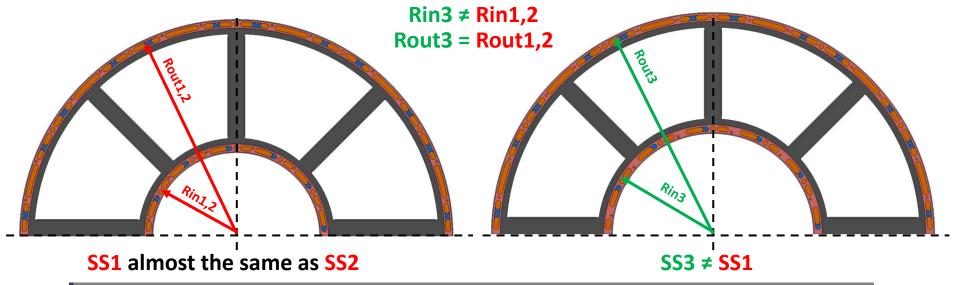


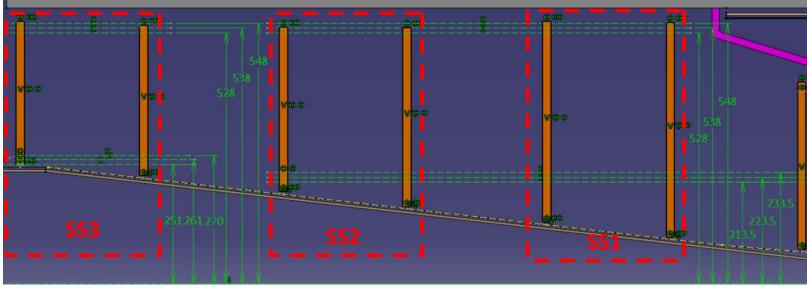


Design of Petals



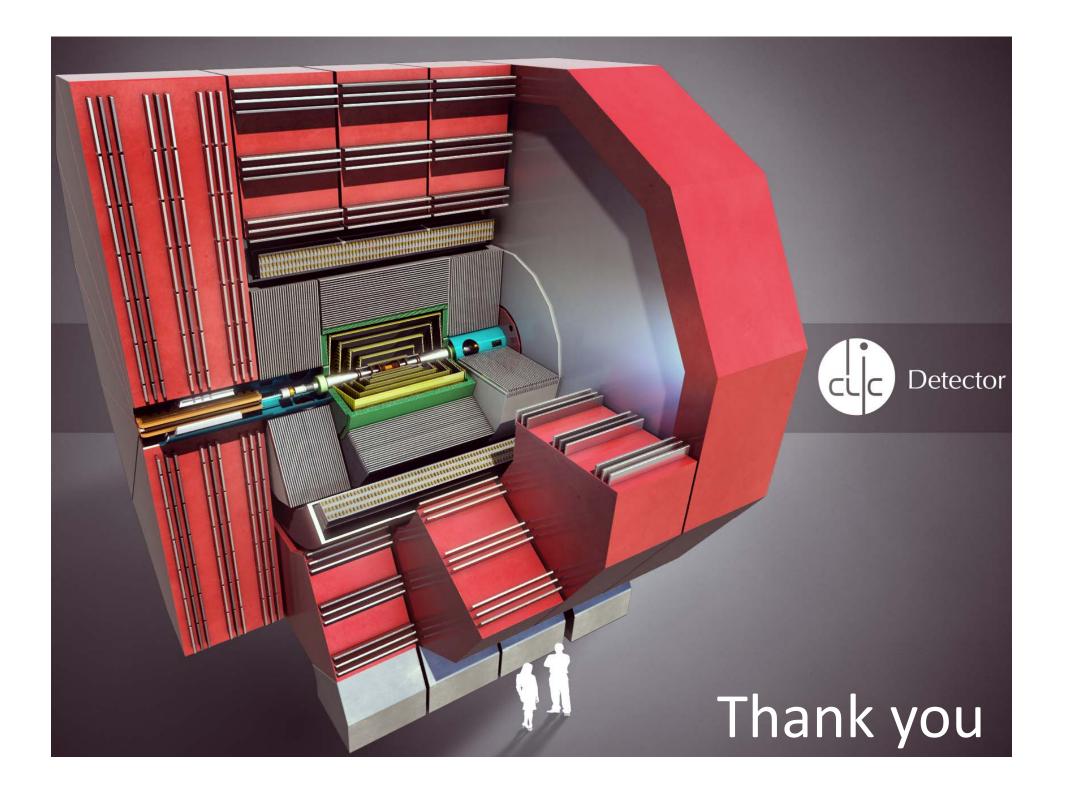
Design of Support Structures





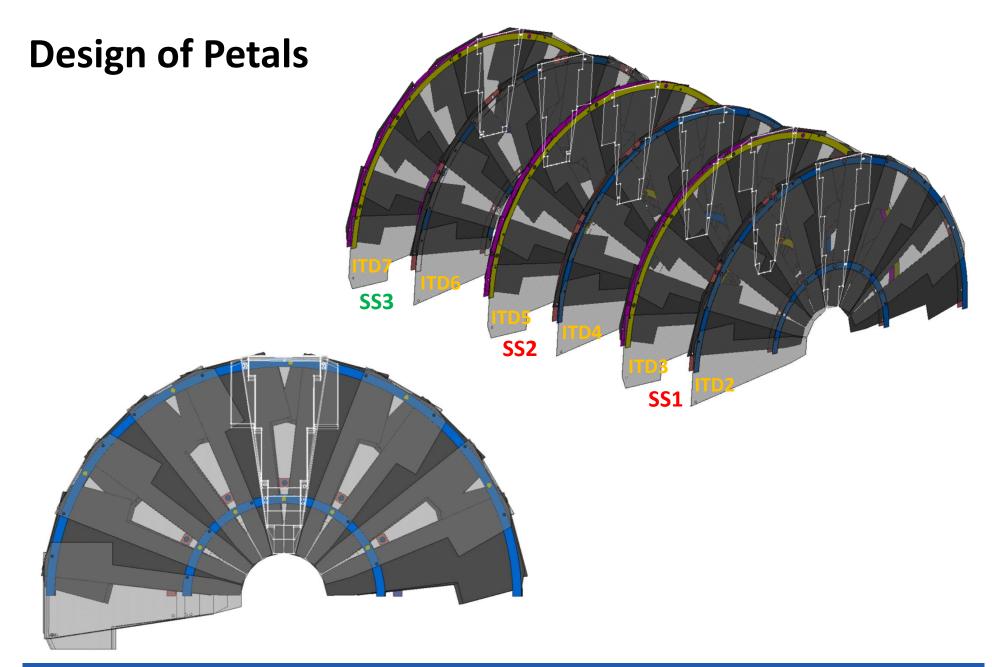
Summary:

- ➤ Design concepts of the mechanical supports for the Inner Tracker Disks & Petals have been shown.
- ➤ Number of designs of the support structures is minimized to two.
- > Design of Petals for the different layers is uniform.
- ➤ Design proposal of the support structures. requests FEA calculations.
- > The concepts need further optimization.



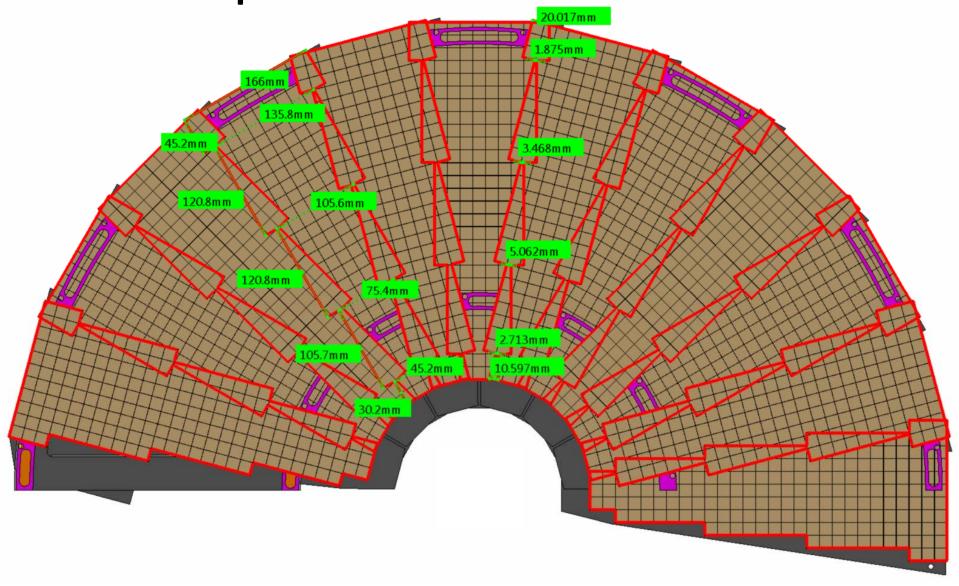
Backup slides



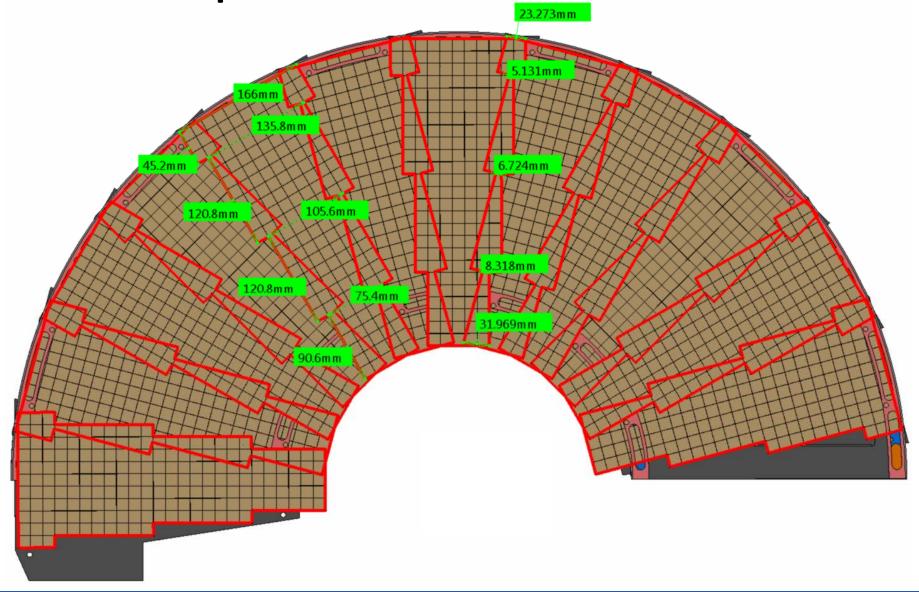




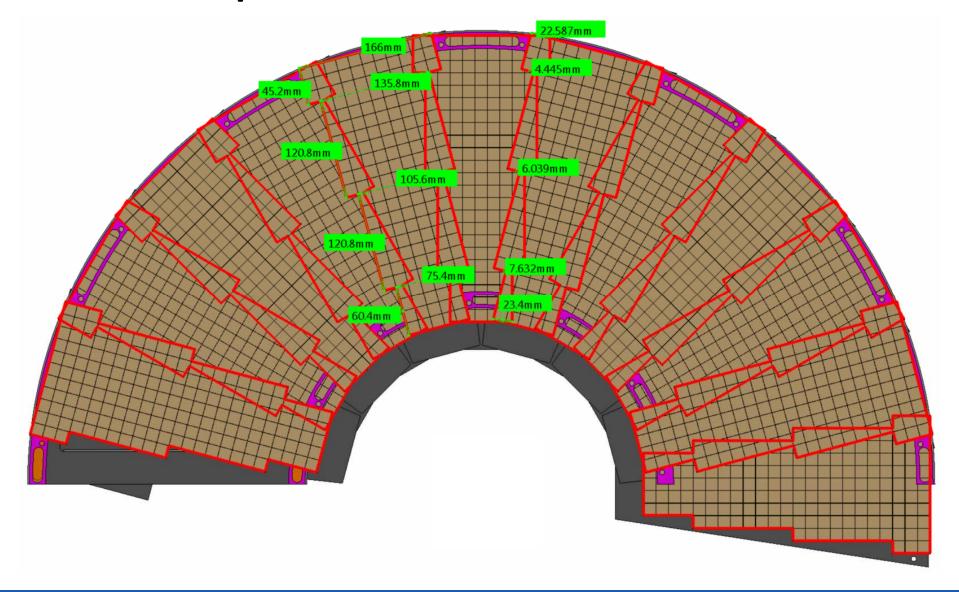
ITD3 - Overlap



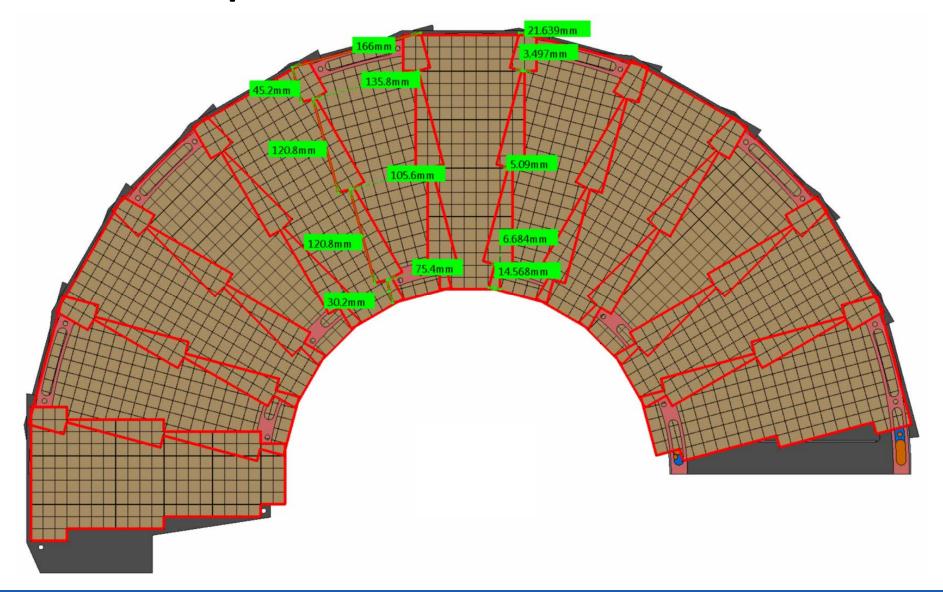
ITD4 - Overlap



ITD5 - Overlap



ITD6 - Overlap



ITD7 - Overlap

